TJA1442

High-speed CAN transceiver with Standby mode

Rev. 2 — 15 October 2021

Product data sheet

1 General description

The TJA1442 is a member of the TJA144x family of transceivers that provide an interface between a Controller Area Network (CAN) or CAN FD (Flexible Data rate) protocol controller and the physical two-wire CAN bus. TJA144x transceivers implement the CAN physical layer as defined in ISO 11898-2:2016 and SAE J2284-1 to SAE J2284-5, and are fully interoperable with high-speed Classical CAN and CAN FD transceivers. All TJA144x variants enable reliable communication in the CAN FD fast phase at data rates up to 5 Mbit/s.

The TJA1442 is intended as a simple replacement for high-speed Classical CAN and CAN FD transceivers, such as the TJA1042 or TJA1044GT from NXP. It offers pin compatibility and is designed to avoid changes to hardware and software design, allowing the TJA1442 to be easily retrofitted to existing applications.

An AEC-Q100 Grade 0 variant, the TJR1442, is available for high temperature applications, supporting operation at 150 °C ambient temperature.

1.1 TJA1442 variants

The TJA1442 comes in two variants, each available in an SO8 or HVSON8 package:

- The TJA1442A is a high-speed CAN transceiver with Normal and Standby modes and a VIO supply pin. The VIO pin allows for direct interfacing with 3.3 V- and 5 V-supplied microcontrollers.
- The TJA1442B is a high-speed CAN transceiver with Normal and Standby modes.

2 Features and benefits

2.1 General

- ISO 11898-2:2016, SAE J2284-1 to SAE J2284-5 and SAE J1939-14 compliant
- Standard CAN and CAN FD data bit rates up to 5 Mbit/s
- Low Electromagnetic Emission (EME) and high Electromagnetic Immunity (EMI)
- · Qualified according to AEC-Q100 Grade 1
- TJA1442A only: VIO input for interfacing with 3.3 V to 5 V microcontrollers
- All variants are available in SO8 and leadless HVSON8 (3.0 mm x 3.0 mm) packages; HVSON8 with improved Automated Optical Inspection (AOI) capability.
- Dark green product (halogen free and Restriction of Hazardous Substances (RoHS) compliant)

2.2 Predictable and fail-safe behavior

· Undervoltage detection with defined handling on all supply pins



High-speed CAN transceiver with Standby mode

- Full functionality guaranteed from the undervoltage detection thresholds up to the maximum limiting voltage values
- Defined behavior below the undervoltage detection thresholds
- Transceiver disengages from the bus (high-ohmic) when the supply voltage drops below the Off mode threshold
- Internal biasing of TXD and mode selection input pins, to enable defined fail-safe behavior

2.3 Low-power management

- · Very low-current Standby mode with host and bus wake-up capability
- \bullet TJA1442A only: CAN wake-up receiver powered by V_{IO} allowing V_{CC} to be shut down
- \bullet CAN wake-up pattern filter time of 0.5 μs to 1.8 μs , meeting Classical CAN and CAN FD requirements

2.4 Protection

- High ESD handling capability on the bus pins (8 kV IEC and HBM)
- Bus pins protected against transients in automotive environments
- Transmit Data (TXD) dominant time-out function
- · Thermally protected

High-speed CAN transceiver with Standby mode

3 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------------|--|--|------|-----|------|------|
| V _{CC} | supply voltage | | 4.5 | - | 5.5 | V |
| I _{cc} | supply current | Normal mode, dominant | - | 38 | 60 | mA |
| | | Normal mode, recessive | - | 4 | 7 | mA |
| | | Standby mode; TJA1442A | - | - | 2 | μΑ |
| | | Standby mode; TJA1442B | - | 8 | 12 | μΑ |
| $V_{uvd(stb)(VCC)}$ | standby undervoltage detection voltage on pin VCC | | 4 | - | 4.5 | V |
| V _{uvhys(stb)(VCC)} | standby undervoltage hysteresis voltage on pin VCC | | 50 | - | - | mV |
| $V_{uvd(swoff)(VCC)}$ | switch-off undervoltage detection voltage on pin VCC | TJA1442B | 2.65 | - | 2.95 | V |
| V _{IO} | supply voltage on pin VIO | | 2.95 | - | 5.5 | V |
| I _{IO} | supply current on pin VIO | Normal mode, dominant; V _{TXD} = 0 V | - | 250 | 760 | μΑ |
| | | Normal mode, recessive; V _{TXD} = V _{IO} | - | 150 | 460 | μΑ |
| | | Standby mode | - | 8 | 11 | μΑ |
| $V_{uvd(swoff)(VIO)}$ | switch-off undervoltage detection voltage on pin VIO | | 2.65 | - | 2.95 | V |
| V _{ESD} | electrostatic discharge voltage | IEC 61000-4-2 on pins CANH and CANL | -8 | - | +8 | kV |
| V _{CANH} | voltage on pin CANH | limiting value according to IEC 60134 | -36 | - | +40 | V |
| V _{CANL} | voltage on pin CANL | limiting value according to IEC 60134 | -36 | - | +40 | V |
| T _{vj} | virtual junction temperature | | -40 | - | +150 | °C |

4 Ordering information

Table 2. Ordering information

| Type number | Package | Package | | | | | | | |
|-------------|---------|--|----------|--|--|--|--|--|--|
| | Name | Description | Version | | | | | | |
| TJA1442AT | SO8 | plastic small outline package; 8 leads; body width 3.9 mm | SOT96-1 | | | | | | |
| TJA1442BT | | | | | | | | | |
| TJA1442ATK | HVSON8 | plastic thermal enhanced very thin small outline package; no | SOT782-1 | | | | | | |
| TJA1442BTK | | leads; 8 terminals; body 3 × 3 × 0.85 mm | | | | | | | |

High-speed CAN transceiver with Standby mode

Table 3. TJA1442 feature overview

See Section 19 for a feature overview of the complete TJx144x/TJx146x/TJF1441 family.

| | Modes | Modes | | | Suppl | lies | | Data ı | ate | Additional features | | | | | | |
|-----------------------|--------|---------|-------|--------------------|----------------|---------|---------|----------|-----------------------|-----------------------|-----------------------------------|---|---|--|----------------------|---------------------------------|
| Device ^[1] | Normal | Standby | Sleep | Silent/Listen-only | Selectable Off | VCC pin | VIO pin | VBAT pin | Up to 5 Mbit/s CAN FD | Up to 8 Mbit/s CAN FD | Signal improvement ^[2] | Wake-up source recognition ^[3] | Short WUP support [0.5 - 1.8 µs] ^[4] | Single supply pin wake-up ^[5] | TXD dominant timeout | Local diagnostics via ERR_N pin |
| TJA1442A | • | • | | | | • | • | | • | | | | • | • | • | |
| TJA1442B | • | • | | | | • | | | • | | | | • | | • | |

TJA1442 is AEC-Q100 Grade 1.

^[1] [2] [3] [4] [5] CAN FD Signal Improvement Capability (SIC) according to CiA 601-4:2019.

RXD is held LOW after wake-up request, enabling wake-up source recognition.

WUP = wake-up pattern according ISO11898-2:2016.

Only VIO supply needed for wake-up in TJA1442A.

High-speed CAN transceiver with Standby mode

5 Block diagram

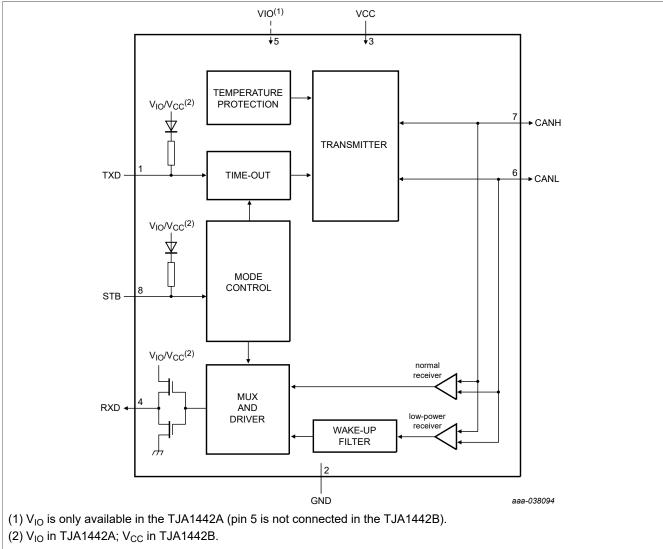
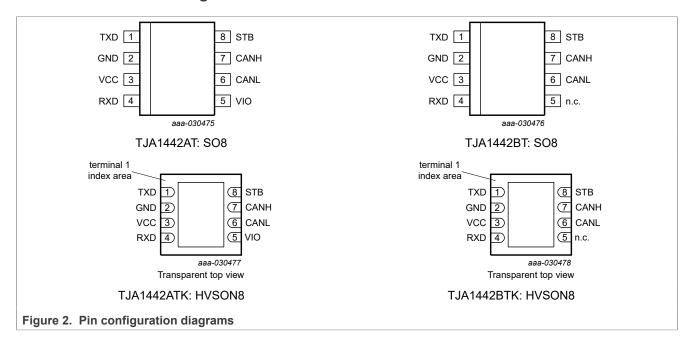


Figure 1. Block diagram

High-speed CAN transceiver with Standby mode

6 Pinning information

6.1 Pinning



6.2 Pin description

Table 4. Pin description

| Symbol | Pin | Type ^[1] | Description |
|--------------------|-----|---------------------|---|
| TXD | 1 | ı | transmit data input; inputs data (from the CAN controller) to be written to the bus lines |
| GND ^[2] | 2 | G | ground |
| VCC | 3 | Р | 5 V supply voltage input |
| RXD | 4 | 0 | receive data output; outputs data read from the bus lines (to the CAN controller) |
| VIO | 5 | Р | supply voltage input for I/O level adapter in TJA1442A |
| n.c. | | - | not connected in TJA1442B |
| CANL | 6 | AIO | LOW-level CAN bus line |
| CANH | 7 | AIO | HIGH-level CAN bus line |
| STB | 8 | I | Standby mode control input; active-HIGH |

^[1] I: digital input; O: digital output; AIO: analog input/output; P: power supply; G: ground.

^[2] HVSON package die supply ground is connected to both the GND pin and the exposed center pad. The GND pin must be soldered to board ground. For enhanced thermal and electrical performance, it is also recommended to solder the exposed center pad to board ground.

High-speed CAN transceiver with Standby mode

7 Functional description

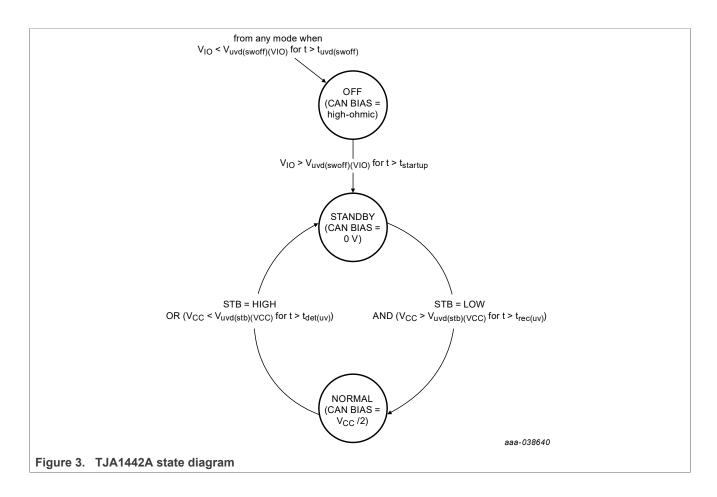
7.1 Operating modes

The TJA1442 supports three operating modes, Normal, Standby and Off. The operating mode is selected via pin STB. See <u>Table 5</u> for a description of the operating modes under normal supply conditions. Mode changes are completed after transition time $\underline{t}_{\underline{t}(moch)}$.

Table 5. Operating modes

| Mode | Inputs | | Outputs | | | | | |
|--------------------|---------|---------|------------------|-----------------------------------|--|--|--|--|
| | Pin STB | Pin TXD | CAN driver | Pin RXD | | | | |
| Normal | LOW | LOW | dominant | LOW | | | | |
| | | HIGH | recessive | LOW when bus dominant | | | | |
| | | | | HIGH when bus recessive | | | | |
| Standby | HIGH | X | biased to ground | follows BUS when wake-up detected | | | | |
| | | | | HIGH when no wake-up detected | | | | |
| Off ^[1] | X | X | high-ohmic state | high-ohmic state | | | | |

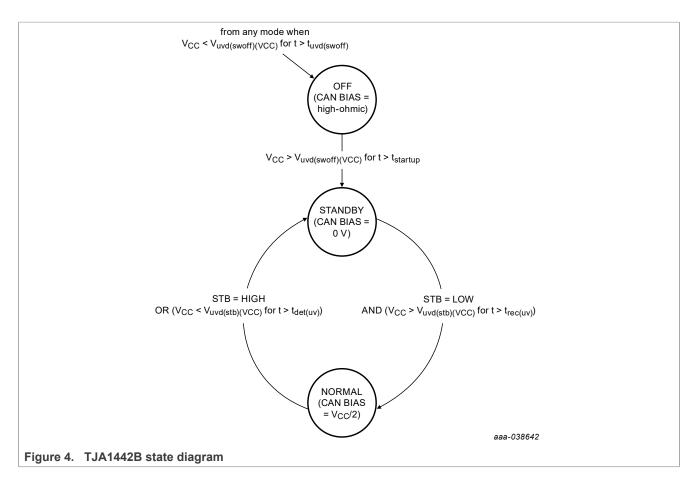
[1] Off mode is entered when the voltage on pin VIO (TJA1442A) or pin VCC (TJA1442B) is below the switch-off undervoltage detection threshold.



TJA1442

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High-speed CAN transceiver with Standby mode



7.1.1 Off mode

The TJA1442 switches to Off mode from any mode when the supply voltage (on pin VIO in the TJA1442A and VCC in the TJA1442B) falls below the switch-off undervoltage threshold ($V_{uvd(swoff)(VCC)}$ or $V_{uvd(swoff)(VIO)}$). This is the default mode when the supply is first connected.

In Off mode, the CAN pins and pin RXD are in a high-ohmic state.

7.1.2 Standby mode

When the supply voltage (V_{IO} for TJA1442A or V_{CC} for TJA1442B) rises above the switch-off undervoltage detection threshold, the TJA1442 starts to boot up, triggering an initialization procedure. The TJA1442 switches to the selected mode after $t_{startup}$.

Standby mode is selected when pin STB goes HIGH. In this mode, the transceiver is unable to transmit or receive data and a low-power receiver is activated to monitor the bus for a wake-up pattern. The transmitter and Normal-mode receiver blocks are switched off and the bus pins are biased to ground to minimize system supply current. Pin RXD follows the bus after a wake-up request has been detected.

A transition to Normal mode is triggered when STB is forced LOW (provided $V_{CC} > V_{uvd(stb)(VCC)}$ and $V_{IO} > V_{uvd(swoff)(VIO)}$ in the TJA1442A).

If V_{CC} is below $V_{uvd(stb)(VCC)}$ when STB goes LOW (with $V_{IO} > V_{uvd(swoff)(VIO)}$ in TJA1442A and $V_{CC} > V_{uvd(swoff)(VCC)}$ in TJA1442B), the TJA1442 will remain in Standby mode.

TJA1442

High-speed CAN transceiver with Standby mode

Pending wake-up events will be cleared and differential data on the bus pins converted to digital data via the low-power receiver and output on pin RXD.

In the TJA1442A, the low-power receiver is supplied from V_{IO} and can detect CAN bus activity when V_{IO} is above $V_{uvd(swoff)(VIO)}$ (even if V_{IO} is the only available supply voltage).

7.1.3 Normal mode

A LOW level on pin STB selects Normal mode, provided the supply voltage on pin VCC is above the standby undervoltage detection threshold, $V_{uvd(stb)(VCC)}$.

In this mode, the transceiver can transmit and receive data via bus lines CANH and CANL. Pin TXD must be HIGH at least once in Normal Mode before transmission can begin. The differential receiver converts the analog data on the bus lines into digital data on pin RXD. The slopes of the output signals on the bus lines are controlled internally and are optimized in a way that guarantees the lowest possible EME. In recessive state, the output voltage on the bus pins is $V_{\rm CC}/2$.

7.1.4 Operating modes and gap-free operation

Gap-free operation guarantees defined behavior at all voltage levels. Supply voltage-to-operating mode mapping is detailed in <u>Figure 5</u> and in the state diagrams (<u>Figure 3</u> and <u>Figure 4</u>).

High-speed CAN transceiver with Standby mode

| | TJA1442A | | | | | | TJA1442B | |
|---------------|--|-----------------|---|--|----------------------------|---------------|--|---|
| | 5.5 V - 6 V ^[1] | | | Fully functional | [2][3] | | 5.5 V - 6 V ^[1] | Fully functional ^{[2][3]} |
| e on VCC | V _{CC} operating range (4.5 V - 5.5 V) | | Fully functional ^{[2][3]} OR Off ^[4] | characteristics guaranteed ^[5] | | e on VCC | V _{CC} operating range (4.5 V - 5.5 V) | Fully functional ^[2] AND characteristics guaranteed ^[5] |
| Voltage range | V _{uvd(stb)(VCC)} range ^[6] | Off | Fully functional ^[2] OR Standby OR Off ^[4] | Fully functional ^[2] OF Standby ^[4] | ₹ | Voltage range | V _{uvd(stb)(VCC)} range | Fully functional ^[2] OR Standby ^[4] |
| Volt | | | | Standby | | Volt | 2.95 V - 4 V | Standby |
| | -0.3 V - 4 V | | Standby OR Off ^[4] | | | | V _{uvd(swoff)(VCC)} range | Standby OR Off ^[4] |
| | | | | | | | | |
| | | -0.3 V - 2.65 V | Vuvd(swoff)(VIO) range ^[6] | V _{IO} operating range (2.95 V - 5.5 V) | 5.5 V - 6 V ^[1] | | | |
| | | | Voltage ra | nge on VIO | | | | |

- [1] 6 V is the IEC 60134 Absolute Maximum Rating (AMR) for VCC and VIO (see Limiting values table). Above the AMR, irreversible changes in characteristics, functionality or performance may occur. Returning from above AMR to the operating range, datasheet characteristics and functionality cannot be guaranteed.
- [2] Target transceiver functionality as described in this datasheet is applicable.
- [3] Prolonged operation of the device outside the operating range may impact reliability over lifetime. Returning to the operating range, datasheet characteristics are guaranteed provided the AMR has not been exceeded.
- [4] For a given value of V_{CC} (and V_{IO} in TJA1442A), a specific device will be in a single defined state determined by its undervoltage detection thresholds (V_{uvd}(stb)(VCC), V_{uvd}(swoff)(VIO) and V_{uvd}(swoff)(VCC)). The actual thresholds can vary between devices (within the ranges specified in this data sheet). To guarantee the device will be in a specific state, V_{IO} and V_{CC} must be either above the maximum or below the minimum thresholds specified for these undervoltage detection ranges.
- [5] Datasheet characteristics are guaranteed within the V_{CC} and V_{IO} operating ranges. Exceptions are described in the Static and Dynamic characteristics tables.
- [6] The following applies to TJA1442A:
 - If both $V_{\hbox{\footnotesize CC}}$ and $V_{\hbox{\footnotesize IO}}$ are above the undervoltage threshold, the device is fully functional.
 - If V_{CC} is below and V_{IO} above the undervoltage threshold, the device is in Standby mode.
 - If V_{IO} is below the undervoltage threshold, the device is in Off mode, regardless of V_{CC} .

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Figure 5. Supply voltage ranges and gap-free operation

7.2 Remote wake-up (via the CAN bus)

The TJA1442 wakes up from Standby mode when a dedicated wake-up pattern (specified in ISO 11898-2: 2016) is detected on the bus.

The wake-up pattern consists of:

- a dominant phase of at least twake(busdom) followed by
- a recessive phase of at least twake(busrec) followed by
- a dominant phase of at least twake(busdom)

Dominant or recessive bits between the above mentioned phases that are shorter than $t_{\text{wake(busdom)}}$ and $t_{\text{wake(busrec)}}$ respectively are ignored.

The complete dominant-recessive-dominant pattern must be received within $\underline{t}_{to(wake)bus}$ to be recognized as a valid wake-up pattern (see Figure 6). Otherwise, the internal wake-up

TJA1442

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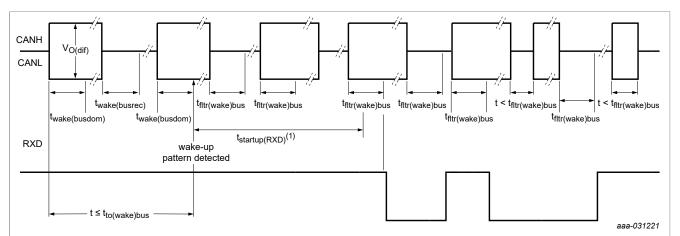
High-speed CAN transceiver with Standby mode

logic is reset. The complete wake-up pattern then needs to be retransmitted to trigger a wake-up event. Pin RXD remains HIGH until the wake-up event has been triggered.

After a wake-up sequence has been detected, the TJA1442 remains in Standby mode with the bus signals reflected on RXD after $\underline{t}_{\underline{startup(RXD)}}$. Note that dominant or recessive phases lasting less than $\underline{t}_{\underline{fltr(wake)bus}}$ will not be detected by the low-power differential receiver and will not be reflected on RXD in Standby mode.

A wake-up event is not flagged on RXD if any of the following events occurs while a valid wake-up pattern is being received:

- · The device switches to Normal mode
- The complete wake-up pattern was not received within tto(wake)bus
- A V_{CC} or V_{IO} switch-off undervoltage is detected ($V_{CC} < V_{uvd(swoff)(VCC)}$ or $V_{IO} < V_{uvd(swoff)(VIO)}$; see Section 7.3.3)



(1) During $t_{startup(RXD)}$, the low-power receiver is on but pin RXD is not active (i.e. HIGH/recessive). The first dominant pulse of width $\geq t_{fltr(wake)bus}$ that ends after $t_{startup(RXD)}$ will trigger RXD to go LOW/dominant.

Figure 6. Wake-up timing

7.3 Fail-safe features

7.3.1 TXD dominant time-out function

A 'TXD dominant time-out' timer is started when pin TXD is set LOW. If the LOW state on this pin persists for longer than $\underline{t}_{to(dom)TXD}$, the transmitter is disabled, releasing the bus lines to recessive state. This function prevents a hardware and/or software application failure from driving the bus lines to a permanent dominant state (blocking all network communications). The TXD dominant time-out timer is reset when pin TXD goes HIGH.

7.3.2 Internal biasing of TXD and STB input pins

Pins TXD and STB have internal pull-ups to V_{CC}/V_{IO} to ensure a safe, defined state in case one, or both, of these pins is left or becomes floating. Pull-up resistors are active on these pins in all states; they should be held at the V_{CC}/V_{IO} level in Standby mode to minimize supply current.

High-speed CAN transceiver with Standby mode

7.3.3 Undervoltage detection on pins VCC and VIO

If V_{CC} drops below the standby undervoltage detection threshold ($V_{uvd(stb)(VCC)}$) for $t_{det(uv)}$, the transceiver switches to Standby mode. The logic state of pin STB is ignored until V_{CC} has recovered.

In the TJA1442A, if V_{IO} drops below the switch-off undervoltage detection threshold $(V_{uvd(swoff)(VIO)})$ for $t_{uvd(swoff)}$, the transceiver switches to Off mode and disengages from the bus (high-ohmic) until V_{IO} has recovered.

In the TJA1442B, if V_{CC} drops below the switch-off undervoltage detection threshold $(V_{uvd(swoff)(VCC)})$ for $t_{uvd(swoff)}$, the transceiver switches to Off mode and disengages from the bus (high-ohmic) until V_{CC} has recovered.

7.3.4 Overtemperature protection

The device is protected against overtemperature conditions. If the junction temperature exceeds the shutdown junction temperature, $T_{j(sd)}$, the CAN bus drivers are disabled. When the junction temperature drops below $T_{j(sd)rel}$, the CAN bus drivers recover once TXD has been reset to HIGH and Normal mode is selected (waiting for TXD to go HIGH prevents output driver oscillation due to small variations in temperature).

7.3.5 I/O levels

Pin VIO on the TJA1442A should be connected to the microcontroller supply voltage (see Figure 10). This adjusts the signal levels on pins TXD, RXD and STB to the I/O levels of the microcontroller, allowing for direct interfacing without additional glue logic. Pin VIO also provides the internal supply voltage for the low-power differential receiver. For applications running in low-power mode, this allows the bus lines to be monitored for activity even if there is no supply voltage on pin VCC.

All I/O levels are related to V_{CC} in the TJA1442B and are, therefore, compatible with 5 V microcontrollers. Spurious signals from the microcontroller on pin STB are filtered out with a filter time of $\underline{t}_{fltr(IO)}$.

High-speed CAN transceiver with Standby mode

Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are referenced to GND, unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------------|---------------------------------------|--|------|------|-------------------------------------|------|
| V _x | voltage on pin x ^[1] | pins VCC, VIO (TJA1442A), TXD, STB | | -0.3 | +6 | V |
| | | | | - | +7 ^[2] | V |
| | | pins CANH, CANL | | -36 | +40 | V |
| | | pin RXD | | | | |
| | | TJA1442A | | -0.3 | V _{IO} +0.3 ^[3] | V |
| | | TJA1442B | | -0.3 | V _{CC} +0.3 ^[3] | V |
| V _(CANH-CANL) | voltage between pin CANH and pin CANL | | | -40 | +40 | V |
| V _{trt} | transient voltage | on pins CANH, CANL | [4] | | | |
| | | pulse 1 | | -100 | - | V |
| | | pulse 2a | | - | +75 | V |
| | | pulse 3a | | -150 | - | V |
| | | pulse 3b | | - | +100 | V |
| V _{ESD} | electrostatic discharge | IEC 61000-4-2 (150 pF, 330 Ω discharge circuit) | [5] | | | |
| | voltage | on pins CANH, CANL | | -8 | +8 | kV |
| | | Human Body Model (HBM) | | | | |
| | | on any pin | | -4 | +4 | kV |
| | | on pins CANH, CANL | [7] | -8 | +8 | kV |
| | | Charged Device Model (CDM) | [8] | | | |
| | | on corner pins | | -750 | +750 | V |
| | | on any other pin | | -500 | +500 | V |
| T _{vj} | virtual junction temperature | | [9] | -40 | +150 | °C |
| T _{stg} | storage temperature | | [10] | -55 | +150 | °C |

The device can sustain voltages up to the specified values over the product lifetime, provided applied voltages (including transients) never exceed these

The device can withstand voltages between 6 V and 7 V for a total of 20 s over the product lifetime.

Subject to the qualifications detailed in Table notes 1 and 2 above for pins VCC, VIO, TXD and STB.

Verified by an external test house according to IEC TS 62228, Section 4.2.4; parameters for standard pulses defined in ISO7637.

Verified by an external test house according to IEC TS 62228, Section 4.3.

According to AEC-Q100-002.

Pins stressed to reference group containing all ground and supply pins, emulating the application circuits (Figure 10 and Figure 11). HBM pulse as specified in AEC-Q100-002 used.

According to AEC-Q100-011.

 ^[9] In accordance with IEC 60747-1. An alternative definition of virtual junction temperature is: T_{vj} = T_{amb} + P × R_{th(j-a)}, where R_{th(j-a)} is a fixed value used in the calculation of T_{vj}. The rating for T_{vj} limits the allowable combinations of power dissipation (P) and ambient temperature (T_{amb}).
 [10] T_{stg} in application according to IEC61360-4. For component transport and storage conditions, see instead IEC61760-2.

High-speed CAN transceiver with Standby mode

9 Thermal characteristics

Table 7. Thermal characteristics

Value determined for free convection conditions on a JEDEC 2S2P board.

| Symbol | Parameter | Conditions ^[1] | Тур | Unit |
|-----------------------|--|---------------------------|-----|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | SO8 | 96 | K/W |
| | | HVSON8 | 57 | K/W |
| R _{th(j-c)} | thermal resistance from junction to case ^[2] | HVSON8 | 19 | K/W |
| $\Psi_{j\text{-top}}$ | thermal characterization parameter from junction to top of package | SO8 | 9 | K/W |
| | | HVSON8 | 9 | K/W |

^[1] According to JEDEC JESD51-2, JESD51-5 and JESD51-7 at natural convection on 2s2p board. Board with two inner copper layers (thickness: 35 μm) and thermal via array under the exposed pad connected to the first inner copper layer (thickness: 70 μm).

10 Static characteristics

Table 8. Static characteristics

 T_{vj} = -40 °C to +150 °C; V_{CC} = 4.5 V to 5.5 V; V_{IO} = 2.95 V to 5.5 V (TJA1442A); R_L = 60 Ω unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC. [1]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|--|---|------|-----|------|------|
| Supply; pin \ | VCC | | | | ' | |
| V _{CC} | supply voltage | | 4.5 | - | 5.5 | V |
| $V_{uvd(stb)}$ | standby undervoltage detection voltage | [2 | 4 | - | 4.5 | V |
| $V_{uvhys(stb)}$ | standby undervoltage hysteresis voltage | | 50 | - | - | mV |
| $V_{uvd(swoff)}$ | switch-off undervoltage detection voltage | TJA1442B [2 | 2.65 | - | 2.95 | V |
| I _{CC} | supply current | Normal mode | | | | |
| | | dominant; $V_{TXD} = 0 \text{ V}$; $t < t_{to(dom)TXD}$ | - | 38 | 60 | mA |
| | | dominant; V _{TXD} = 0 V; short circuit on bus lines; -3 V < (V _{CANH} = V _{CANL}) < +40 V | - | - | 125 | mA |
| | | recessive; V _{TXD} = V _{IO} ^[3] | - | 4 | 7 | mA |
| | | Standby mode | | | | |
| | | TJA1442A; T _{vj} < 85 °C | - | - | 2 | μΑ |
| | | TJA1442B; T _{vj} < 85 °C | - | 8 | 12 | μΑ |
| I/O level ada | apter supply; pin VIO (TJA1442 | 2A) | ' | ' | ' | ' |
| V _{IO} | supply voltage | | 2.95 | - | 5.5 | V |
| $V_{uvd(swoff)}$ | switch-off undervoltage detection voltage | [2 | 2.65 | - | 2.95 | V |
| I _{IO} | supply current Normal mode, dominant; V _{TXD} = 0 V | | | | 760 | μΑ |
| | | Normal mode, recessive; $V_{TXD} = V_{IO}$ | - | 150 | 460 | μA |

TJA1442

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^[2] Case temperature refers to the center of the heatsink at the bottom of the package.

High-speed CAN transceiver with Standby mode

Table 8. Static characteristics...continued

 T_{vj} = -40 °C to +150 °C; V_{CC} = 4.5 V to 5.5 V; V_{IO} = 2.95 V to 5.5 V (TJA1442A); R_L = 60 Ω unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC. [1]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|----------------------------------|---|-----------------------------------|-----|-----------------------------------|------|
| | | Standby mode; T _{vj} < 85 °C | - | 8 | 11 | μΑ |
| CAN transm | nit data input; pin TXD | | | | · | |
| V _{IH} | HIGH-level input voltage | | 0.7V _{IO} ^[3] | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.3V _{IO} ^[3] | V |
| $V_{hys(TXD)}$ | hysteresis voltage on pin TXD | | 50 | - | - | mV |
| R _{pu} | pull-up resistance | | 20 | - | 80 | kΩ |
| Ci | input capacitance | [4] | - | - | 10 | pF |
| CAN receive | e data output; pin RXD | | | 1 | | ' |
| I _{ОН} | HIGH-level output current | $V_{RXD} = V_{IO}^{[3]} - 0.4 \text{ V}$ | -10 | - | -1 | mA |
| I _{OL} | LOW-level output current | V _{RXD} = 0.4 V; bus dominant | 1 | - | 10 | mA |
| Standby cor | ntrol input; pin STB | | , | | | |
| V _{IH} | HIGH-level input voltage | | 0.7V _{IO} ^[3] | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.3V _{IO} ^[3] | V |
| V _{hys} | hysteresis voltage | | 50 | - | - | mV |
| R _{pu} | pull-up resistance | | 20 | - | 80 | kΩ |
| Ci | input capacitance | [4] | - | - | 10 | pF |
| Bus lines; p | ins CANH and CANL | | | 1 | | , |
| V _{O(dom)} | dominant output voltage | $V_{TXD} = 0 \text{ V}; \text{ t} < \text{t}_{to(dom)TXD}; V_{CC} \ge 4.75 \text{ V}$ | | | | |
| | | pin CANH; R _L = 50 Ω to 65 Ω | 2.75 | 3.5 | 4.5 | V |
| | | pin CANL; R _L = 50 Ω to 65 Ω | 0.5 | 1.5 | 2.25 | V |
| V_{TXsym} | transmitter voltage symmetry | $V_{TXsym} = V_{CANH} + V_{CANL};$ [4] $C_{SPLIT} = 4.7 \text{ nF};$ [5] $f_{TXD} = 250 \text{ kHz}, 1 \text{ MHz or } 2.5 \text{ MHz}$ | | - | 1.1V _{CC} | V |
| V _{cm(step)} | common mode voltage step | [4] [5] [6] | 130 | - | +150 | mV |
| $V_{cm(p-p)}$ | peak-to-peak common mode voltage | [4] [5] [6] | | - | +300 | mV |
| $V_{O(dif)}$ | differential output voltage | dominant; Normal mode; $V_{TXD} = 0 \text{ V}$; $t < t_{to(dom)TXD}$; $V_{CC} \ge 4.75 \text{ V}$ | | | | |
| | | $R_L = 50 \Omega$ to 65Ω | 1.5 | - | 3 | V |
| | | R_L = 45 Ω to 70 Ω | 1.4 | - | 3.3 | V |
| | | $R_L = 2240 \Omega$ [4] | 1.5 | _ | 5 | V |
| | | recessive; no load | | | | |
| | | Normal mode; V _{TXD} = V _{IO} ^[3] | -50 | - | +50 | mV |

High-speed CAN transceiver with Standby mode

Table 8. Static characteristics...continued

 T_{vj} = -40 °C to +150 °C; V_{CC} = 4.5 V to 5.5 V; V_{IO} = 2.95 V to 5.5 V (TJA1442A); R_L = 60 Ω unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC. [1]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|--|------|-----|------|------|
| | | Standby mode | -0.2 | - | +0.2 | V |
| V _{O(rec)} | recessive output voltage | Normal mode; $V_{TXD} = V_{IO}^{[3]}$; no load | 2 | 2.5 | 3 | V |
| | | Standby mode; no load | -0.1 | - | +0.1 | V |
| $V_{th(RX)dif}$ | differential receiver threshold voltage | -12 V ≤ V _{CANH} ≤ +12 V; -12 V ≤ V _{CANL} ≤ +12 V | | | | |
| | | Normal mode | 0.5 | - | 0.9 | V |
| | | Standby mode | 0.4 | - | 1.1 | V |
| V _{rec(RX)} | receiver recessive voltage | -12 V ≤ V _{CANH} ≤ +12 V; -12 V ≤ V _{CANL} ≤ +12 V | | | | |
| | | Normal mode | -4 | - | +0.5 | V |
| | | Standby mode | -4 | - | +0.4 | V |
| $V_{dom(RX)}$ | receiver dominant voltage | -12 V ≤ V _{CANH} ≤ +12 V; -12 V ≤ V _{CANL} ≤ +12 V | | | | |
| | | Normal mode | 0.9 | - | 9 | V |
| | | Standby mode | 1.1 | - | 9 | V |
| $V_{hys(RX)dif}$ | differential receiver hysteresis voltage | -12 V ≤ V _{CANH} ≤ +12 V; -12 V ≤ V _{CANL} ≤ +12 V; Normal mode | 50 | - | - | mV |
| I _{O(sc)} | short-circuit output current | -15 V ≤ V _{CANH} ≤ +40 V; -15 V ≤ V _{CANL} ≤ +40 V | - | - | 115 | mA |
| I _{O(sc)rec} | recessive short-circuit output current | -27 V \leq V _{CANH} \leq +32 V; -27 V \leq V _{CANL} \leq +32 V; Normal mode; V _{TXD} = V _{IO} ^[3] | -3 | - | +3 | mA |
| IL | leakage current | $V_{CC} = V_{IO} = 0 \text{ V or pins shorted to GND}$ via 47 K Ω ; $V_{CANH} = V_{CANL} = 5 \text{ V}$ | -10 | - | +10 | μA |
| R _i | input resistance | -2 V ≤ V _{CANL} ≤ +7 V; -2 V ≤ V _{CANH} ≤ +7 V | 25 | 40 | 50 | kΩ |
| ΔR _i | input resistance deviation | $0 \text{ V} \le V_{CANL} \le +5 \text{ V}; 0 \text{ V} \le V_{CANH} \le +5 \text{ V}$ | -3 | - | +3 | % |
| R _{i(dif)} | differential input resistance | -2 V ≤ V _{CANL} ≤ +7 V; -2 V ≤ V _{CANH} ≤ +7 V | 50 | 80 | 100 | kΩ |
| C _{i(cm)} | common-mode input capacitance | [4 |] _ | - | 20 | pF |
| C _{i(dif)} | differential input capacitance | [4 |] _ | - | 10 | pF |
| Temperature | edetection | | | 1 | | |
| $T_{j(sd)}$ | shutdown junction temperature | [4 | 180 | - | 200 | °C |
| T _{j(sd)rel} | release shutdown junction temperature | [4 | 175 | - | 195 | °C |
| | I I | | 1 | 1 | 1 | 1 |

^[1] All parameters are guaranteed over the virtual junction temperature range by design. Factory testing uses correlated test conditions to cover the specified temperature and power supply voltage ranges.

TJA1442

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^[2] Undervoltage is detected between min and max values. Undervoltage is guaranteed to be detected below min value and guaranteed not to be detected above max value.

High-speed CAN transceiver with Standby mode

- V_{CC} in TJA1442B

 Not tested in production; guaranteed by design.

 The test circuit used to measure the bus output voltage symmetry and the common-mode voltages (which includes C_{SPLIT}) is shown in Figure 13. [3] [4] [5] [6]

High-speed CAN transceiver with Standby mode

11 Dynamic characteristics

Table 9. Dynamic characteristics

 T_{vj} = -40 °C to +150 °C; V_{CC} = 4.5 V to 5.5 V; V_{IO} = 2.95 V to 5.5 V (TJA1442A); R_L = 60 Ω unless specified otherwise; all voltages are defined with respect to ground. [1]

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------------|---|--|------------|-----|-----|----------|------|
| CAN timing cl | haracteristics; t _{bit(TXD)} ≥ 200 ns; see <u>Figure 7</u> | Figure 8 and Figure 12 | | | | | |
| t _{d(TXD-busdom)} | delay time from TXD to bus dominant | Normal mode | | - | - | 102.5 | ns |
| t _{d(TXD-busrec)} | delay time from TXD to bus recessive | Normal mode | | - | - | 102.5 | ns |
| t _{d(busdom-RXD)} | delay time from bus dominant to RXD | Normal mode | | - | - | 115 | ns |
| t _{d(busrec-RXD)} | delay time from bus recessive to RXD | Normal mode | | _ | - | 115 | ns |
| t _{d(TXDL-RXDL)} | delay time from TXD LOW to RXD LOW | Normal mode | - | - | 215 | ns | |
| t _{d(TXDH-RXDH)} | delay time from TXD HIGH to RXD HIGH | Normal mode | | - | - | 215 | ns |
| CAN FD timin | ng characteristics according to ISO 11898-2:2 | 016; see <u>Figure 8</u> and <u>Figure 1</u> | 2 | | | ' | |
| t _{bit(bus)} | transmitted recessive bit width | t _{bit(TXD)} = 500 ns | | 435 | - | 530 | ns |
| | | t _{bit(TXD)} = 200 ns | | 155 | - | 210 | ns |
| Δt_{rec} | receiver timing symmetry | $t_{bit(TXD)} = 500 \text{ ns}$ | | -65 | - | +40 | ns |
| | | $t_{bit(TXD)}$ = 200 ns | | -45 | - | +15 | ns |
| t _{bit(RXD)} | bit time on pin RXD | $t_{bit(TXD)} = 500 \text{ ns}$ | | 400 | - | 550 | ns |
| | | t _{bit(TXD)} = 200 ns | | 120 | - | 220 | ns |
| Dominant time | e-out time; pin TXD | | | | | <u>'</u> | |
| to(dom)TXD | TXD dominant time-out time | V _{TXD} = 0 V; Normal mode | [2] [3] | 0.8 | - | 9 | ms |
| Bus wake-up | times; pins CANH and CANL; <u>Figure 6</u> | | | | | | |
| twake(busdom) | bus dominant wake-up time | Standby mode | [2] [4] | 0.5 | - | 1.8 | μs |
| twake(busrec) | bus recessive wake-up time | Standby mode | [2] [4] | 0.5 | - | 1.8 | μs |
| to(wake)bus | bus wake-up time-out time | Standby mode | [2] [3] | 0.8 | - | 9 | ms |
| t _{fltr(wake)bus} | bus wake-up filter time | Standby mode | [2] | - | - | 1.8 | μs |
| Mode transition | ons | | | | | | |
| <u>t_{t(moch)}</u> | mode change transition time | | [2] | _ | - | 50 | μs |
| <u>t</u> startup | start-up time | | [2] | - | - | 1 | ms |
| t _{startup(RXD)} | RXD start-up time | after wake-up detected | [2] [5] | 4 | - | 20 | μs |
| IO filter; pin S | ТВ | | | | | | |
| t _{fltr(IO)} | IO filter time | | [6] | 1 | - | 5 | μs |
| | detection; Figure 3 and Figure 4 | | | | | | |
| t _{det(uv)} | undervoltage detection time | on pin VCC | [2] | - | - | 30 | μs |
| t _{uvd(swoff)} | switch-off undervoltage detection time | on pin VCC; TJA1442B | [2] | _ | - | 30 | μs |

TJA1442

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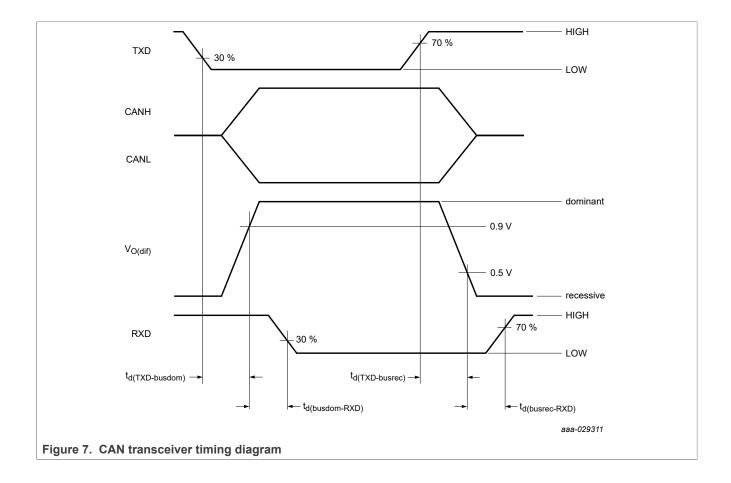
High-speed CAN transceiver with Standby mode

Table 9. Dynamic characteristics...continued

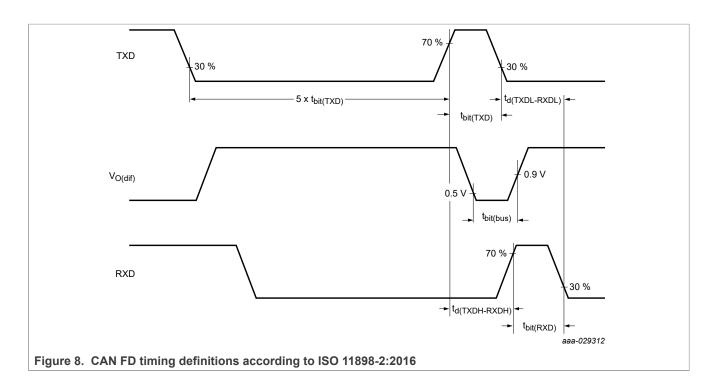
 T_{vj} = -40 °C to +150 °C; V_{CC} = 4.5 V to 5.5 V; V_{IO} = 2.95 V to 5.5 V (TJA1442A); R_L = 60 Ω unless specified otherwise; all voltages are defined with respect to ground. [1]

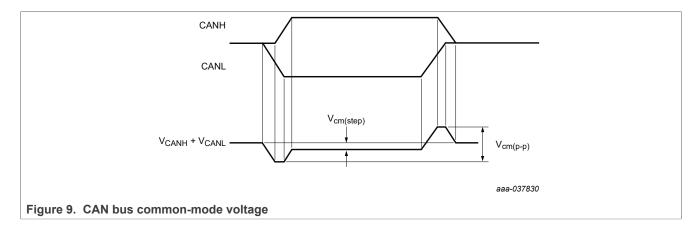
| Symbol | Parameter | Conditions | | Тур | Max | Unit |
|----------------------|----------------------------|--------------------------|---|-----|-----|------|
| | | on pin VIO; TJA1442A [2] | | | 30 | μs |
| t _{rec(uv)} | undervoltage recovery time | on pin VCC [2] | - | - | 50 | μs |

- [1] All parameters are guaranteed over the junction temperature range by design. Factory testing uses correlated test conditions to cover the specified temperature and power supply voltage ranges.
- 2] Not tested in production; guaranteed by design.
- [3] Time-out occurs between the min and max values. Time-out is guaranteed not to occur below the min value; time-out is guaranteed to occur above the max value.
- [4] A dominant/recessive phase shorter than the min value is guaranteed not be seen as a dominant/recessive bit; a dominant/recessive phase longer than the max value is guaranteed to be seen as a dominant/recessive bit.
- [5] When a wake-up is detected, RXD start-up time is between the min and max values. RXD cannot be relied on below the min value; RXD can be relied on above the max value; see Figure 6.
- [6] Pulses shorter than the min value are guaranteed to be filtered out; pulses longer than the max value are guaranteed to be processed.



High-speed CAN transceiver with Standby mode

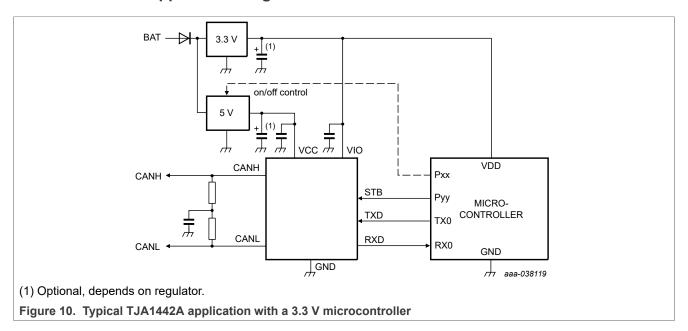


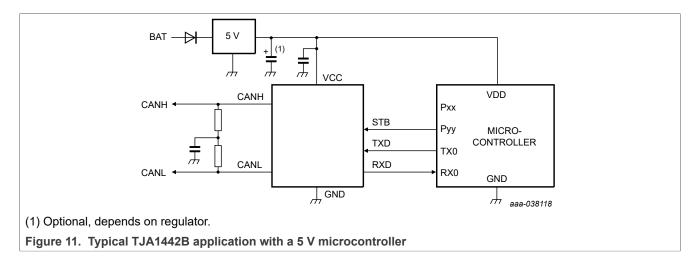


High-speed CAN transceiver with Standby mode

12 Application information

12.1 Application diagrams



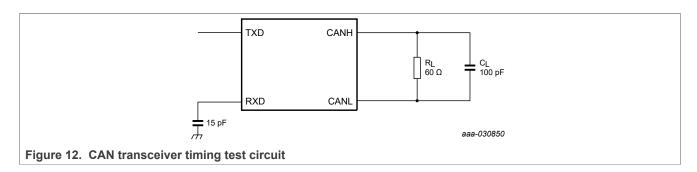


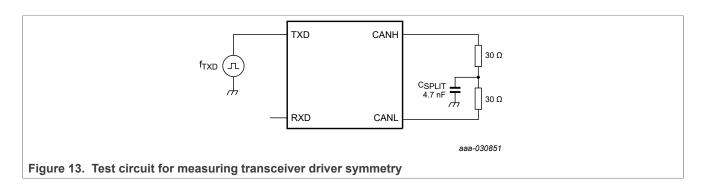
12.2 Application hints

Further information on the application of the TJA1442 can be found in NXP application hints AH2002 'TJx144x/TJx146x Application Hints', available on request from NXP Semiconductors.

High-speed CAN transceiver with Standby mode

13 Test information



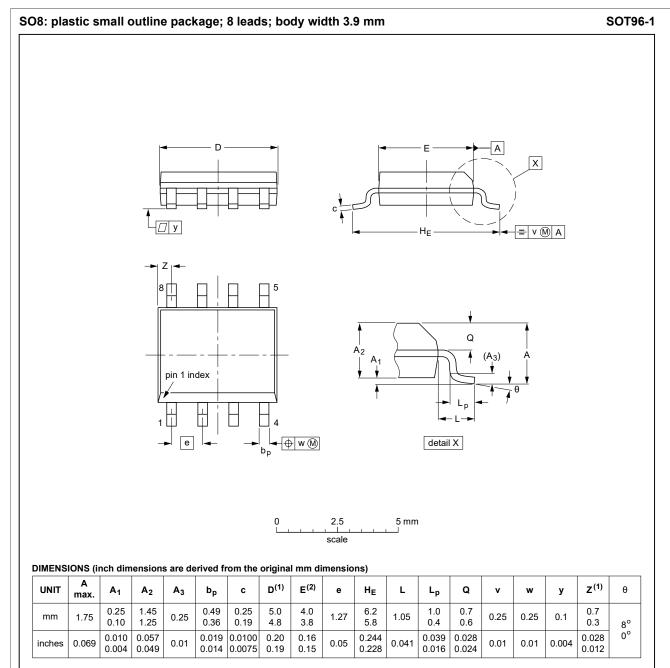


13.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 Rev-H - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

High-speed CAN transceiver with Standby mode

14 Package outline



Notes

- 1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|---------|-----------|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC JEDEC | | JEITA | | PROJECTION | ISSUE DATE | |
| SOT96-1 | 076E03 | MS-012 | | | | 99-12-27 03-02-18 | |

Figure 14. Package outline SOT96-1 (SO8)

TJA1442

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High-speed CAN transceiver with Standby mode

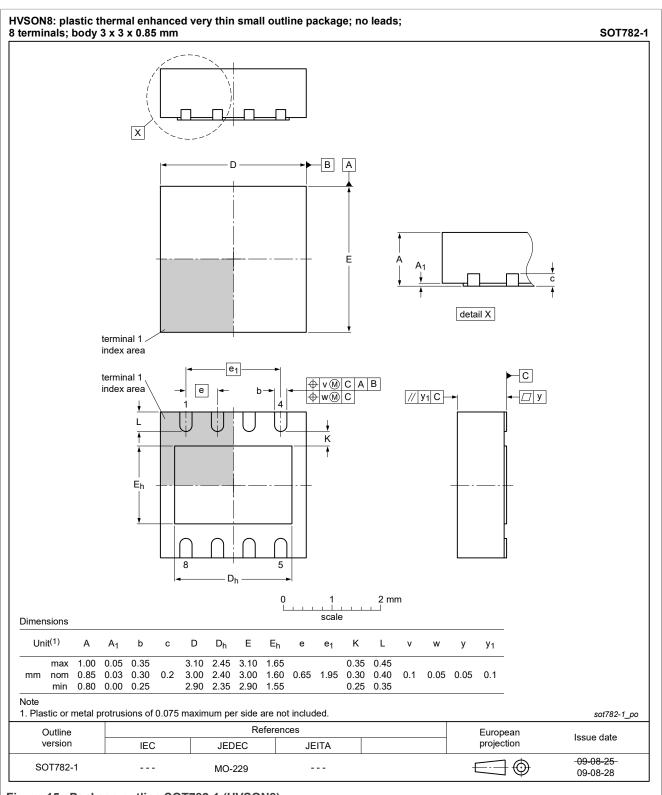


Figure 15. Package outline SOT782-1 (HVSON8)

High-speed CAN transceiver with Standby mode

15 Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

16 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

16.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

16.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- · Package placement
- Inspection and repair
- · Lead-free soldering versus SnPb soldering

16.3 Wave soldering

Key characteristics in wave soldering are:

TJA1442

High-speed CAN transceiver with Standby mode

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

16.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 16</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board
 is heated to the peak temperature) and cooling down. It is imperative that the peak
 temperature is high enough for the solder to make reliable solder joints (a solder
 paste characteristic). In addition, the peak temperature must be low enough that the
 packages and/or boards are not damaged. The peak temperature of the package
 depends on package thickness and volume and is classified in accordance with
 Table 10 and Table 11

Table 10. SnPb eutectic process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) | | | | | |
|------------------------|---------------------------------|-------|--|--|--|--|
| | Volume (mm³) | | | | | |
| | < 350 | ≥ 350 | | | | |
| < 2.5 | 235 | 220 | | | | |
| ≥ 2.5 | 220 | 220 | | | | |

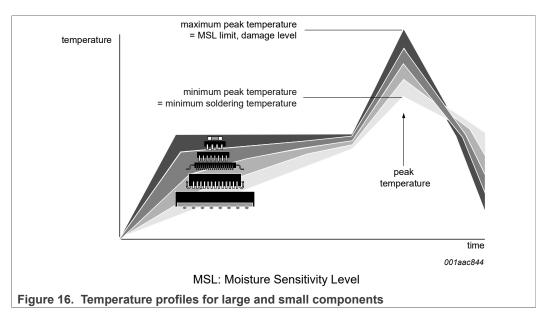
Table 11. Lead-free process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) Volume (mm³) | | | | | | |
|------------------------|---|-------------|--------|--|--|--|--|
| | | | | | | | |
| | < 350 | 350 to 2000 | > 2000 | | | | |
| < 1.6 | 260 | 260 | 260 | | | | |
| 1.6 to 2.5 | 260 | 250 | 245 | | | | |
| > 2.5 | 250 | 245 | 245 | | | | |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see <u>Figure 16</u>.

High-speed CAN transceiver with Standby mode



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

17 Soldering of HVSON packages

<u>Section 16</u> contains a brief introduction to the techniques most commonly used to solder Surface Mounted Devices (SMD). A more detailed discussion on soldering HVSON leadless package ICs can be found in the following application note:

• AN10365 "Surface mount reflow soldering description"

High-speed CAN transceiver with Standby mode

18 Appendix: ISO 11898-2:2016 parameter cross-reference list

Table 12. ISO 11898-2:2016 to NXP data sheet parameter conversion

| ISO 11898-2:2016 | | NXP data she | eet |
|---|--|---------------------------|---|
| Parameter | Notation | Symbol | Parameter |
| HS-PMA dominant output characteristics | | | |
| Single ended voltage on CAN_H | V _{CAN_H} | $V_{O(dom)}$ | dominant output voltage |
| Single ended voltage on CAN_L | V _{CAN_L} | | |
| Differential voltage on normal bus load | V_{Diff} | V _{O(dif)} | differential output voltage |
| Differential voltage on effective resistance during arbitration | | | |
| Optional: Differential voltage on extended bus load range | | | |
| HS-PMA driver symmetry | | | |
| Driver symmetry | V_{SYM} | V_{TXsym} | transmitter voltage symmetry |
| Maximum HS-PMA driver output current | | | |
| Absolute current on CAN_H | I _{CAN_H} | I _{O(sc)} | short-circuit output current |
| Absolute current on CAN_L | I _{CAN_L} | | |
| HS-PMA recessive output characteristics, bus biasing ac | ctive/inacti | ve | |
| Single ended output voltage on CAN_H | V _{CAN_H} | V _{O(rec)} | recessive output voltage |
| Single ended output voltage on CAN_L | V _{CAN_L} | | |
| Differential output voltage | V_{Diff} | V _{O(dif)} | differential output voltage |
| Optional HS-PMA transmit dominant time-out | | | |
| Transmit dominant time-out, long | t _{dom} | $t_{to(dom)TXD}$ | TXD dominant time-out time |
| Transmit dominant time-out, short | | | |
| HS-PMA static receiver input characteristics, bus biasing | g active/ina | active | |
| Recessive state differential input voltage range Dominant state differential input voltage range | V_{Diff} | $V_{th(RX)dif}$ | differential receiver threshold voltage |
| | | V _{rec(RX)} | receiver recessive voltage |
| | | $V_{dom(RX)}$ | receiver dominant voltage |
| HS-PMA receiver input resistance (matching) | | | |
| Differential internal resistance | R _{Diff} | R _{i(dif)} | differential input resistance |
| Single ended internal resistance | R _{CAN_H} R _{CAN_L} | R _i | input resistance |
| Matching of internal resistance | MR | ΔR_i | input resistance deviation |
| HS-PMA implementation loop delay requirement | | | -, |
| Loop delay | t _{Loop} | t _{d(TXDH-RXDH)} | delay time from TXD HIGH to RXD HIGH |
| | | $t_{d(TXDL-RXDL)}$ | delay time from TXD LOW to RXD LOW |

High-speed CAN transceiver with Standby mode

Table 12. ISO 11898-2:2016 to NXP data sheet parameter conversion...continued

| ISO 11898-2:2016 | | NXP data she | et |
|---|-----------------------|-------------------------------|---------------------------------------|
| Parameter | Notation | Symbol | Parameter |
| Optional HS-PMA implementation data signal timing req Mbit/s and above 2 Mbit/s up to 5 Mbit/s | uirements | for use with bit | rates above 1 Mbit/s up to 2 |
| Transmitted recessive bit width @ 2 Mbit/s / @ 5 Mbit/s, intended | t _{Bit(Bus)} | t _{bit(bus)} | transmitted recessive bit width |
| Received recessive bit width @ 2 Mbit/s / @ 5 Mbit/s | t _{Bit(RXD)} | t _{bit(RXD)} | bit time on pin RXD |
| Receiver timing symmetry @ 2 Mbit/s / @ 5 Mbit/s | Δt_{Rec} | Δt_{rec} | receiver timing symmetry |
| HS-PMA maximum ratings of V_{CAN_H} , V_{CAN_L} and V_{Diff} | _ | | · |
| Maximum rating V _{Diff} | V_{Diff} | V _(CANH-CANL) | voltage between pin CANH and pin CANL |
| General maximum rating V _{CAN_H} and V _{CAN_L} | V _{CAN_H} | V _x | voltage on pin x |
| Optional: Extended maximum rating VCAN_H and VCAN_L | V _{CAN_L} | | |
| HS-PMA maximum leakage currents on CAN_H and CAN | I_L, unpow | ered | |
| Leakage current on CAN_H, CAN_L | I _{CAN_H} | IL | leakage current |
| HS-PMA bus biasing control timings | | | |
| CAN activity filter time, long | t _{Filter} | t _{wake(busdom)} [1] | bus dominant wake-up time |
| CAN activity filter time, short | | t _{wake(busrec)} | bus recessive wake-up time |
| Wake-up time-out, short | t _{Wake} | t _{to(wake)bus} | bus wake-up time-out time |
| Wake-up time-out, long | | | |

 $^{[1] \}hspace{0.5cm} \textbf{t}_{\text{fltr}(\text{wake})\text{bus}} \text{ - bus wake-up filter time, in devices with basic wake-up functionality}$

High-speed CAN transceiver with Standby mode

19 Appendix: TJx144x/TJx146x/TJF1441 family overview

Table 13. Feature overview of the complete TJx144x/TJx146x/TJF1441 family

| | Mode | es | | | | Supp | lies | , | Data | rate | Addit | ional f | eatures | S | | |
|-----------------------|--------|---------|-------|--------------------|----------------|---------|---------|----------|-----------------------|--------------------------------------|-----------------------------------|---|---|--|----------------------|---------------------------------|
| Device ^[1] | Normal | Standby | Sleep | Silent/Listen-only | Selectable Off | VCC pin | VIO pin | VBAT pin | Up to 5 Mbit/s CAN FD | Up to 8 Mbit/s CAN FD ^[2] | Signal improvement ^[3] | Wake-up source recognition ^[4] | Short WUP support [0.5 - 1.8 µs] ^[5] | Single supply pin wake-up ^[6] | TXD dominant timeout | Local diagnostics via ERR_N pin |
| TJx1441A | • | | | • | | • | • | | • | | | | | | • | |
| TJx1441B | • | | | • | | • | | | • | | | | | | • | |
| TJx1441D | • | | | • | • | • | | | • | | | | | | • | |
| TJF1441A | • | | | • | | • | • | | • | | | | | | [7] | |
| TJx1442A | • | • | | | | • | • | | • | | | | • | • | • | |
| TJx1442B | • | • | | | | • | | | • | | | | • | | • | |
| TJx1443A | • | • | • | • | | • | • | • | • | | | • | • | • | • | • |
| TJx1448A | • | • | | | | • | • | | • | | | | • | • | • | |
| TJx1448B | • | • | | | | • | | | • | | | | • | | • | |
| TJx1448C | • | • | | | | • | • | | • | | | • | • | • | • | |
| TJx1462A | • | • | | | | • | • | | • | • | • | | • | • | • | |
| TJx1462B | • | • | | | | • | | | • | • | • | | • | | • | |
| TJx1463A | • | • | • | • | | • | • | • | • | • | • | • | • | • | • | • |

- TJx: TJA14xxx is AEC-Q100 Grade 1; TJR14xxx is AEC-Q100 Grade 0; TJF1441A is non-automotive grade. Only guaranteed for TJA146x, AEC-Q100 Grade 1.
- CAN FD Signal Improvement Capability (SIC) according to CiA 601-4:2019.
- RXD is held LOW after wake-up request, enabling wake-up source recognition.
- WUP = wake-up pattern according ISO11898-2:2016.
- Only VIO supply needed for wake-up in TJA1442A, TJA1448A, TJA1448C, TJA1462A; only VBAT supply needed for wake-up in TJA1443A, TJA1463A.
- Not having TXD dominant timeout allows for very low data rates in non-automotive grade applications.

20 Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | | |
|---------------|--|---|---------------|-------------|--|--|--|
| TJA1442 v.2 | 20211015 | Product data sheet | - | TJA1442 v.1 | | | |
| Modifications | <u>Table 6</u>: Table no <u>Table 9</u>: CAN de t_{startup(RXD)} revise | Added device (Table 3) and family (Section 19) feature overviews Table 6: Table note 10 added Table 9: CAN delay timing characteristics revised; measurement conditions for parameter t_{startup(RXD)} revised Section 21: Suitability for use in Automotive applications and Security disclaimers revised | | | | | |
| TJA1442 v.1 | 20200812 | Product data sheet | - | - | | | |

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21 Legal information

21.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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High-speed CAN transceiver with Standby mode

Contents

| 1 | General description | 1 |
|-------|--|----|
| 1.1 | TJA1442 variants | 1 |
| 2 | Features and benefits | 1 |
| 2.1 | General | |
| 2.2 | Predictable and fail-safe behavior | |
| 2.3 | Low-power management | 2 |
| 2.4 | Protection | 2 |
| 3 | Quick reference data | |
| 4 | Ordering information | 3 |
| 5 | Block diagram | |
| 6 | Pinning information | |
| 6.1 | Pinning | |
| 6.2 | Pin description | |
| 7 | Functional description | |
| 7.1 | Operating modes | |
| 7.1.1 | Off mode | |
| 7.1.2 | Standby mode | |
| 7.1.3 | Normal mode | |
| 7.1.4 | Operating modes and gap-free operation | |
| 7.2 | Remote wake-up (via the CAN bus) | |
| 7.3 | Fail-safe features | 11 |
| 7.3.1 | TXD dominant time-out function | |
| 7.3.2 | Internal biasing of TXD and STB input pins | 11 |
| 7.3.3 | Undervoltage detection on pins VCC and | |
| | VIO | 12 |
| 7.3.4 | Overtemperature protection | |
| 7.3.5 | I/O levels | |
| 8 | Limiting values | |
| 9 | Thermal characteristics | |
| 10 | Static characteristics | |
| 11 | Dynamic characteristics | |
| 12 | Application information | |
| 12.1 | Application diagrams | |
| 12.2 | Application hints | |
| 13 | Test information | |
| 13.1 | Quality information | |
| 14 | Package outline | |
| 15 | Handling information | |
| 16 | Soldering of SMD packages | |
| 16.1 | Introduction to soldering | |
| 16.2 | Wave and reflow soldering | |
| 16.3 | Wave soldering | |
| 16.4 | Reflow soldering | |
| 17 | Soldering of HVSON packages | 27 |
| 18 | Appendix: ISO 11898-2:2016 parameter | |
| | cross-reference list | 28 |
| 19 | Appendix: TJx144x/TJx146x/TJF1441 | _ |
| | family overview | 30 |
| 20 | Revision history | |
| 21 | l egal information | 31 |

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